JICA Innovative Asia - Tokyo Tech

Admission Date: September 22, 2017 Number of Students to be Accepted: 13

Program Type(s): Research Student Program, (Master's Program, Doctoral Program)

Application Period: March 1 - May 2, 2017

1. General Prospectus

The Innovative Asia initiative, conducted by JICA (Japan International Cooperation Agency), aims to enhance the circulation of competent human resources between Japan and Asian countries and to promote innovation throughout Asia, by providing students from 12 Asian countries with opportunities to conduct research, enroll in master's or doctoral degree programs at Japanese universities and participate in internships with Japanese companies.

Officially dispatched students under the program will enroll in Tokyo Institute of Technology (Tokyo Tech) as Research Students in the Research Student Program starting from September 2017.

Participants who pass the entrance examination for **April 2018** will be eligible to enroll in Tokyo Tech's master's or doctoral degree Programs. Those who do not pass the entrance examination must return to their home countries.

2. Program

Please refer to General Information (1st Batch) for details. (PDF/339KB)

Standard Timetable at Tokyo Tech:

- 1. September 2017 March 2018 (Research students, 6 months)
- 2. Degree-seeking students
 - April 2018 March 2020 (For master's students, 2 years)
 - April 2018 March 2021 (For doctoral students, 3 years)
- Participants must participate in an Internship during summer break and may remain in Japan for up to 6
 months in an internship after program completion.

NOTE:

 Students who enter the master's degree program under Innovative Asia may not proceed to the doctoral program at Tokyo Tech.

Reference Information:

- JICA Innovative Asia HP: https://www.jica.go.jp/english/countries/asia/innovative_asia.html
- Tokyo Tech HP: http://www.titech.ac.jp/english/graduate_school/international/research_students/jica.html

Necessary Preparations for coming to Tokyo Tech (to be announced)

3. Qualifications and JICA Financial Support

Please refer to General Information (1st Batch) for details. (PDF)

NOTE:

Applicants must graduate or have graduated from a JICA-designated partner school before September

2017.

4. Application Procedures

Application Form Download (WORD)

Application Deadline: May 2, 2017

1. Finding an Academic Supervisor

Prior to submitting application materials to the International Student Exchange Division, applicants must arrange for a Tokyo Tech faculty member to serve as an academic supervisor and undergo an initial interview before the stated application deadline. In order to be considered for admission, the applicant must first find an academic supervisor. The applicant is required to communicate directly with his/her intended academic supervisor at Tokyo Tech and obtain the consent of the desired faculty member to serve in this capacity. The applicant must directly contact the intended academic supervisor via email and provide a self-introductory statement and a letter of intent for his/her period of study at Tokyo Tech.

The applicant must request that his/her academic supervisor write a "Letter of Acceptance". The academic supervisor must fill out the form and submit it to the International Student Exchange Division by the stated deadline. The "Letter of Acceptance" will serve as one of the applicant's documents to be considered during the application screening process.

For further information on our faculty members, please refer to the "STAR Search" (Researchers' Database)

on Tokyo Tech's web site.

Some academic supervisors may require the submission of additional documents before the stated deadline.

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2. Documents to be Submitted

(1) Check sheet and Questionnaire (Form 1) (double-sided printing)

(2) Application Form (Form 2) (double-sided printing, original, no photocopies)

Photograph (4.5×3.5 cm, taken within the past six months, upper body, full-faced) Write your name and nationality on the reverse side. The photograph must be pasted on the application form. Digital photograph inserted in the form is also acceptable.

(3) Research plan or Research Status sheet [Research Proposal] (Form 3) (double-sided printing)

(4) Official Academic Transcripts

- Bachelor's degree holders: Submit transcripts from undergraduate school(s) (originals or certified copies)
- Master's / Doctoral degree holders: Submit transcripts from both undergraduate and graduate schools (originals or certified copies)

(5) Certificate of Graduation or Expected Graduation

- Bachelor's degree holders: Submit certificates from undergraduate school(s) (originals or certified copies)
- Master's / Doctoral degree holders: Submit certificates from both undergraduate and graduate schools (originals or certified copies)

(6) Summary of Thesis (free format)

Applicants who have not written a formal thesis are requested to submit the details of research he/she conducted at his/her home university.

(7) English Proficiency Test Score Report (original, no photocopies)

Applicants are required to submit an English proficiency test score report from **TOEFL-iBT**, **TOEFL-PBT**, **TOEIC** or the IELTS Academic Module taken on or after May 3, 2015. Score reports from TOEFL-ITP, TOEIC-IP or other proficiency tests not specifically listed above will not be accepted.

Applicants can request ETS or the British Council to send an official score report directly to Tokyo Institute of Technology. Tokyo Institute of Technology's institutional code number for TOEFL is "0215".

- (8) Evaluation Sheet with a Recommendation Letter from a Supervisor, Head of Department, etc. of the last university attended to verify the potential of applicant (Form 4) (original, no photocopies)
- (9) Copy of Applicant's Passport (the page(s) with applicant's name, nationality, date of birth and photo)

3. Submission of Application Documents

The completed application documents must reach the International Student Exchange Division no later than the application deadline by registered mail, courier service or a similar service.

Note:

1. These documents must be written in either Japanese or English. A document written in any other

language must be attached with a Japanese or English translation.

2. Tokyo Tech will not accept any documents received after the stated deadline or any incomplete

applications.

3. Tokyo Tech cannot respond to any inquiries regarding receipt of individual application documents. The

applicant is responsible for the tracking and receipt of all materials. Tokyo Tech strongly encourages

sending the documents by registered mail, courier service or a similar service that provides tracking

numbers and receipt verification services.

4. Submitted documents will not be returned under any circumstances. Tokyo Tech will not provide

photocopies of the submitted documents. Please keep a copy of all documents for personal reference.

In the event that a document cannot be re-issued, please submit a certified copy instead.

5. Admission may be withdrawn at any time, even after enrollment, if the application documents are found

to be invalid or containing any false information.

4. Notification of the Application Results

In June 2017, Tokyo Tech will announce its selection of candidates to be recommended for the program.

Successful candidates will be evaluated by JICA from the viewpoint of potential to contribute to the national

development of the home country and must be officially approved as participants of the program by the

respective government and JICA. Each approved participant's status as "officially dispatched student" should

be endorsed by their home country's government. At this stage, every participant is requested to fill out and

submit an Application Form to the JICA office for formal procedures.

5. Necessary Preparations for coming to Tokyo Tech

Necessary Preparations for coming to Tokyo Tech (to be announced)

CONTACT:

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